

Board Level Cooling – High Rise 5308



BOARD LEVEL COOLING – High Rise 5308

High Rise 5308 is a series of narrow high rise channel board level heat sinks designed to cool TO-218, TO-220, TO-220-single gauge, and TO-247 devices. Representative image only.



ORDERING INFORMATION

Part Number	Device Type
530801B05150G	TO-220, TO-220-single gauge
530861B05162G	TO-218, TO-247

HEAT SINK DETAILS

Property	Details
Material	Aluminum
Finishing	Black Anodize
Device Attachment Options	Kool Clip 62
Thermal Interface Material	-

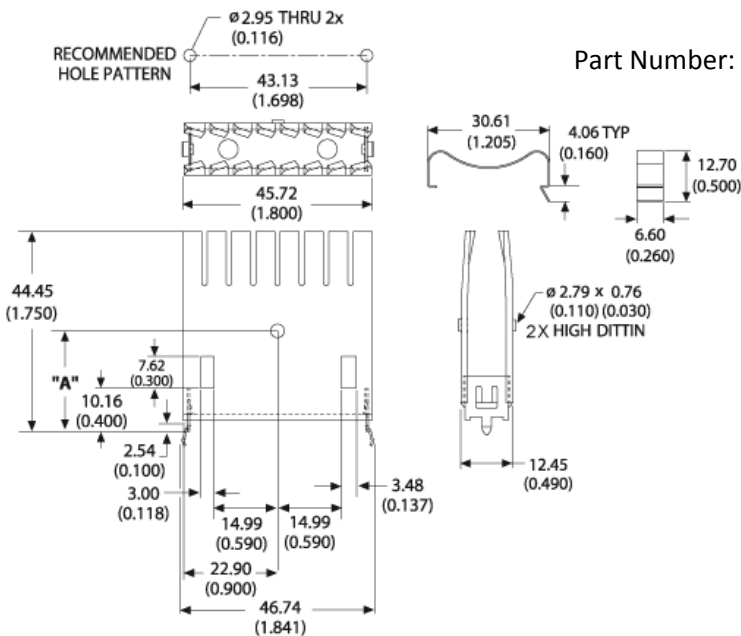
Property	Details
Heat Sink Width (mm)	45.70
Heat Sink Length (mm)	12.45
Heat Sink Height (mm)	44.45
Heat Sink Mounting Direction	Vertical

MECHANICAL & PERFORMANCE

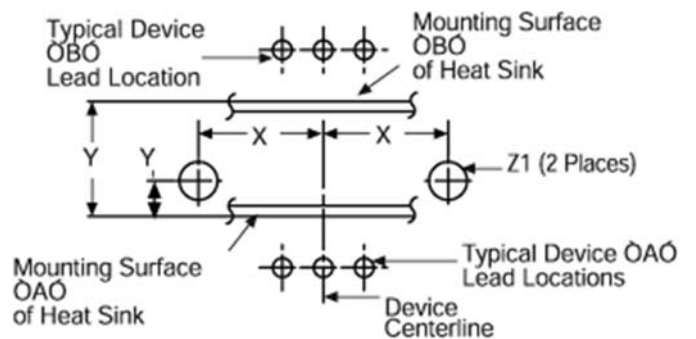
Drawing dimensions are shown in mm, (in)

Part Number	"A" Dim	"X" Dim	"YT" Dim	"Y" Dim	"Z" Dim
530801B05150G	21.8	21.56 (0.849)	12.70 (0.500)	6.35 (0.250)	2.95 (0.116)
530861B05162G	21.8	-	-	-	-

Part Number: 530801B05150G



Mounting Details:



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Part Number: 530861B05162G

